

AMENDMENTS TO THE SPECIFICATION:

Please amend the title of the referenced application as follows:

**METHOD OF FORMING A FLIP CHIP ASSEMBLY AND METHOD FOR
PRODUCING THE SAME**

On page 1, after the title, please amend the following paragraph:

This is a divisional application of U.S. Patent Application Serial No. 10/118,002, filed April 9, 2002 (now abandoned), the disclosure of which is incorporated herein in its entirety.